

MSE 170 Final review part 2

- Exam date: 12/9/2008 Tues, 8:30-10:20
- Place: Here!
- Closed book, no notes and no collaborations
- Two sheets of letter-sized paper with double-sided notes is allowed
- Exam is comprehensive: material on the exam will be taken from the text book reading, lecture notes, homework, and lab
- Bring a calculator and straight edge/triangle
- The review materials are not comprehensive, there may be questions on the exam on topics not listed here

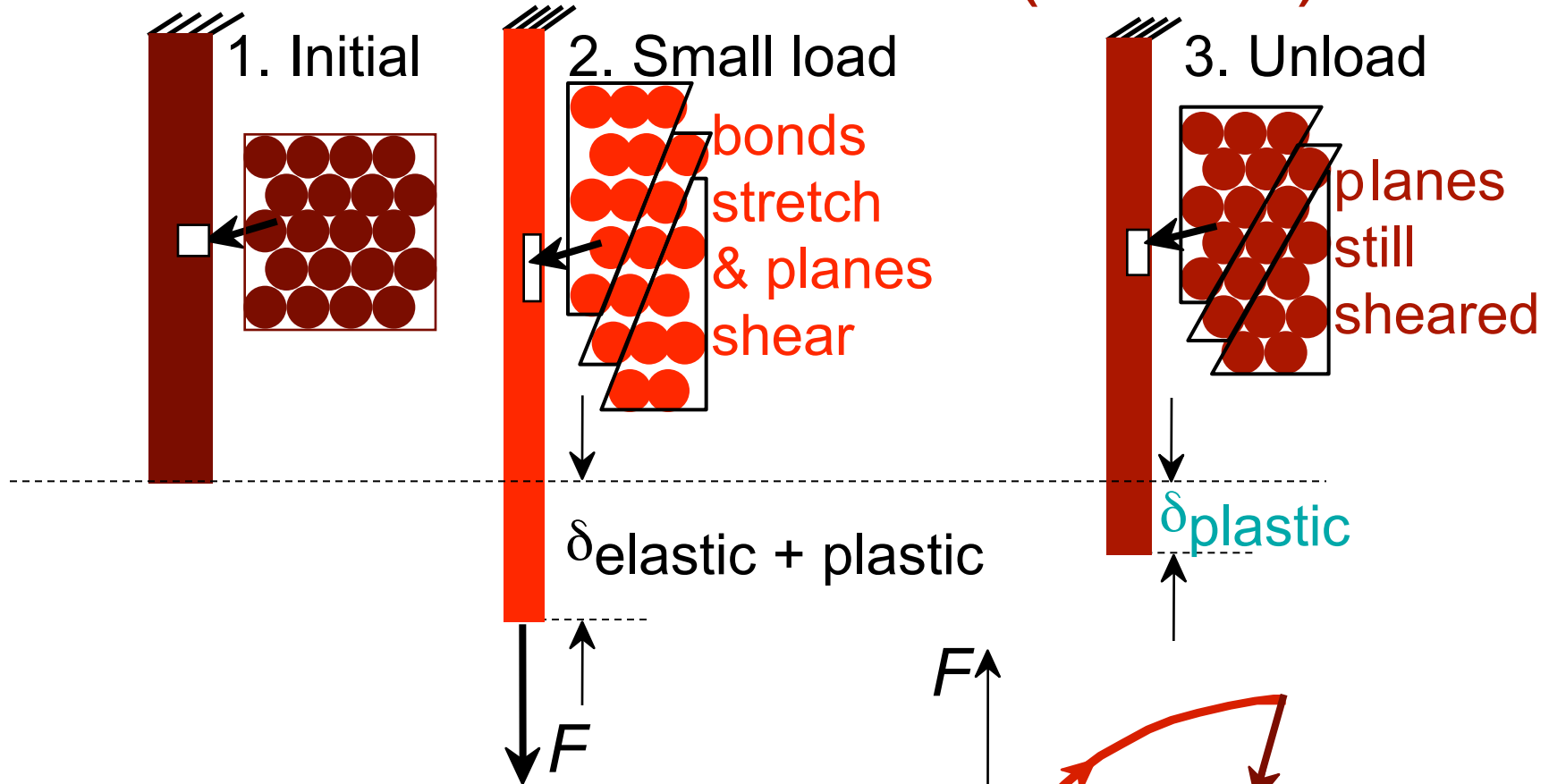


Plastic deformation

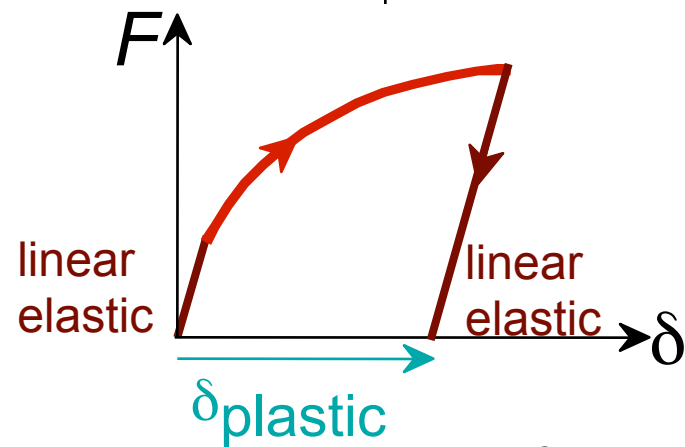
- Slip plane, direction and system, resolved shear stress
- Mechanism of plastic deformation
- Strengthening mechanisms
- Recovery, recrystallization, and grain growth



Plastic Deformation (Metals)



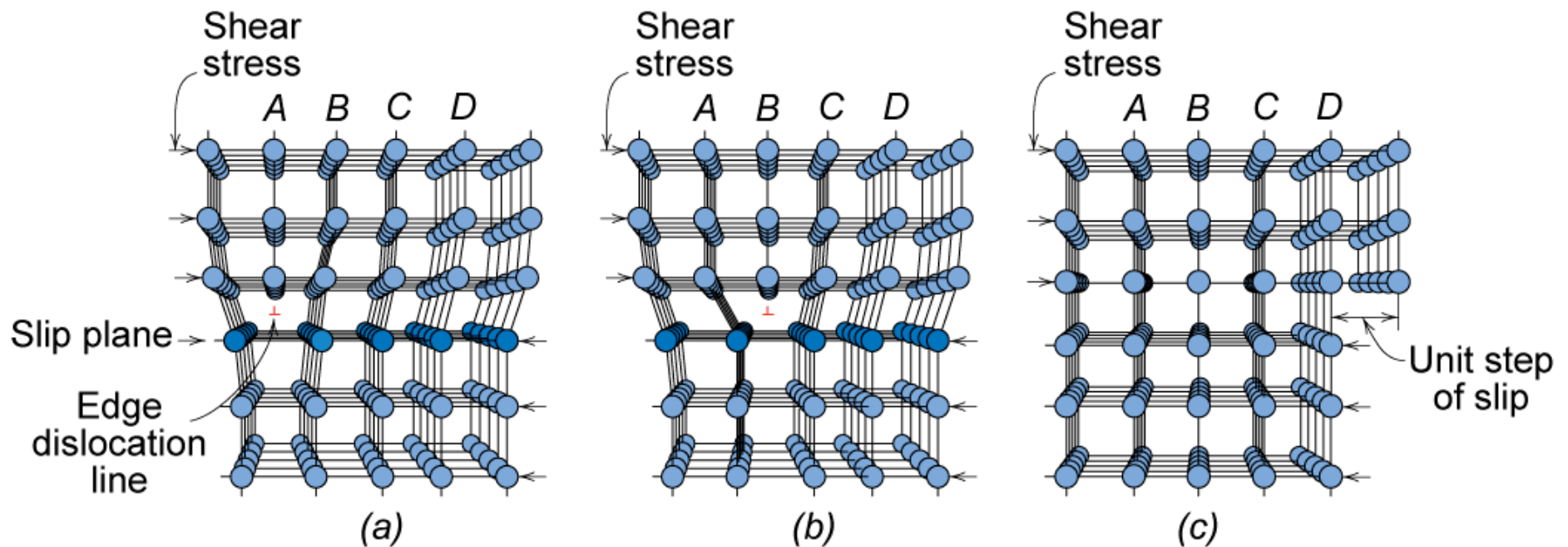
Plastic means **permanent!**



Dislocation Motion

Dislocations & plastic deformation

- Cubic & hexagonal metals - plastic deformation by **plastic shear or slip** where one plane of atoms slides over adjacent plane by defect motion (dislocations).



- If dislocations don't move, deformation doesn't occur!

Adapted from Fig. 7.1,
Callister 7e.

Chapter 2 - 4



Failure

- Ductile vs brittle fracture
- Stress concentrations and fracture toughness
- Creep and fatigue failure



Phase diagram

- Solubility limits, solidus, liquidus
- Binary isomorphous and eutectic phase diagrams
- Eutectic, peritectic, eutectoid reactions
- Lever law, weight fraction of phases
- Composition and microstructure of equilibrium phases



Aside: a touch of Thermodynamics

Enthalpy~ Internal Energy

↓

$$\Delta G = \Delta H - T\Delta S$$

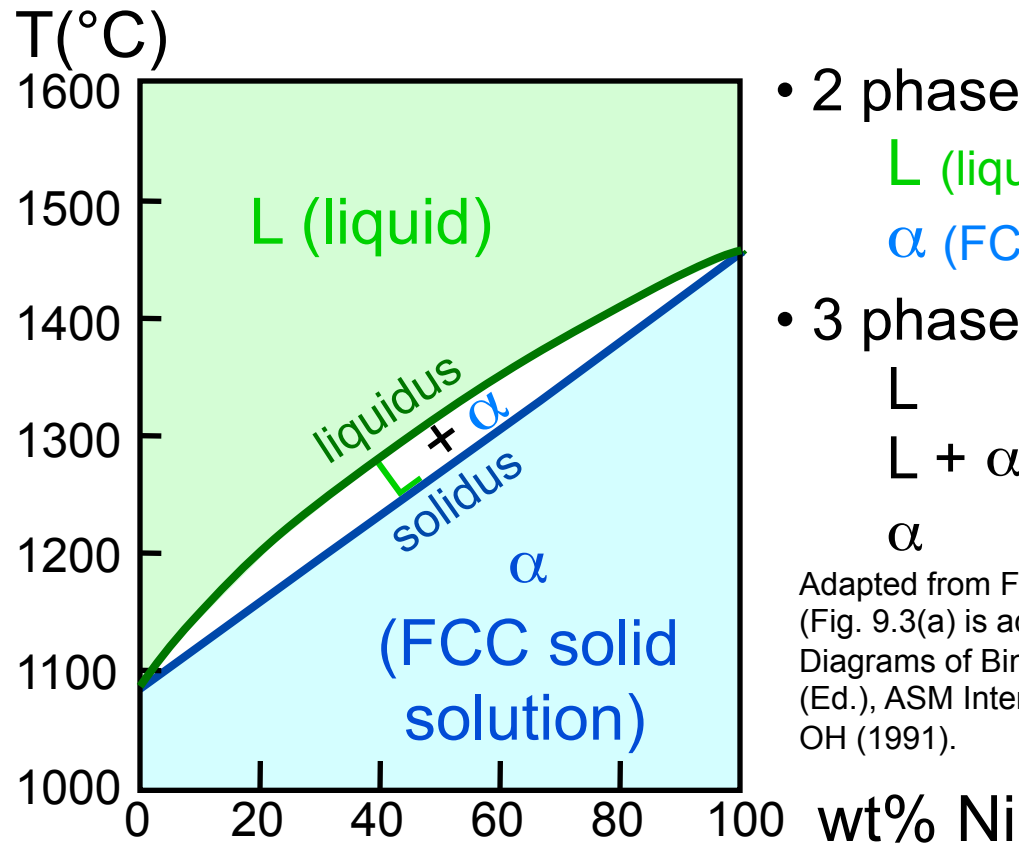
Gibb's free Energy Entropy~ disorder~ probability

A transformation will occur spontaneously if ΔG is negative.

Phase Diagrams

- Indicate phases as function of T , C_0 , and P .
- For this course:
 - binary systems: just 2 components.
 - independent variables: T and C_0 ($P = 1 \text{ atm}$ is almost always used).

- Phase Diagram for Cu-Ni system



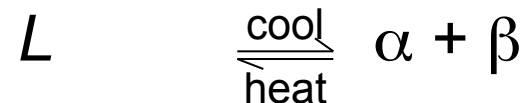
- 2 phases:
 - L (liquid)
 - α (FCC solid solution)
- 3 phase fields:
 - L
 - $L + \alpha$
 - α

Adapted from Fig. 9.3(a), Callister 7e.
(Fig. 9.3(a) is adapted from Phase Diagrams of Binary Nickel Alloys, P. Nash (Ed.), ASM International, Materials Park, OH (1991).

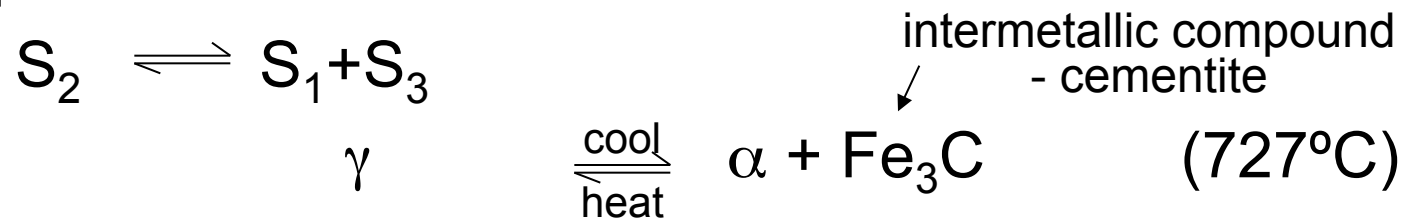


Eutectoid & Peritectic

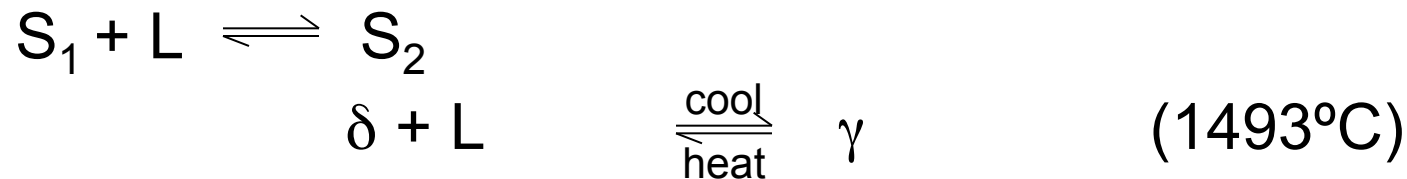
- **Eutectic** - liquid in equilibrium with two solids



- **Eutectoid** - solid phase in equilibrium with two solid phases

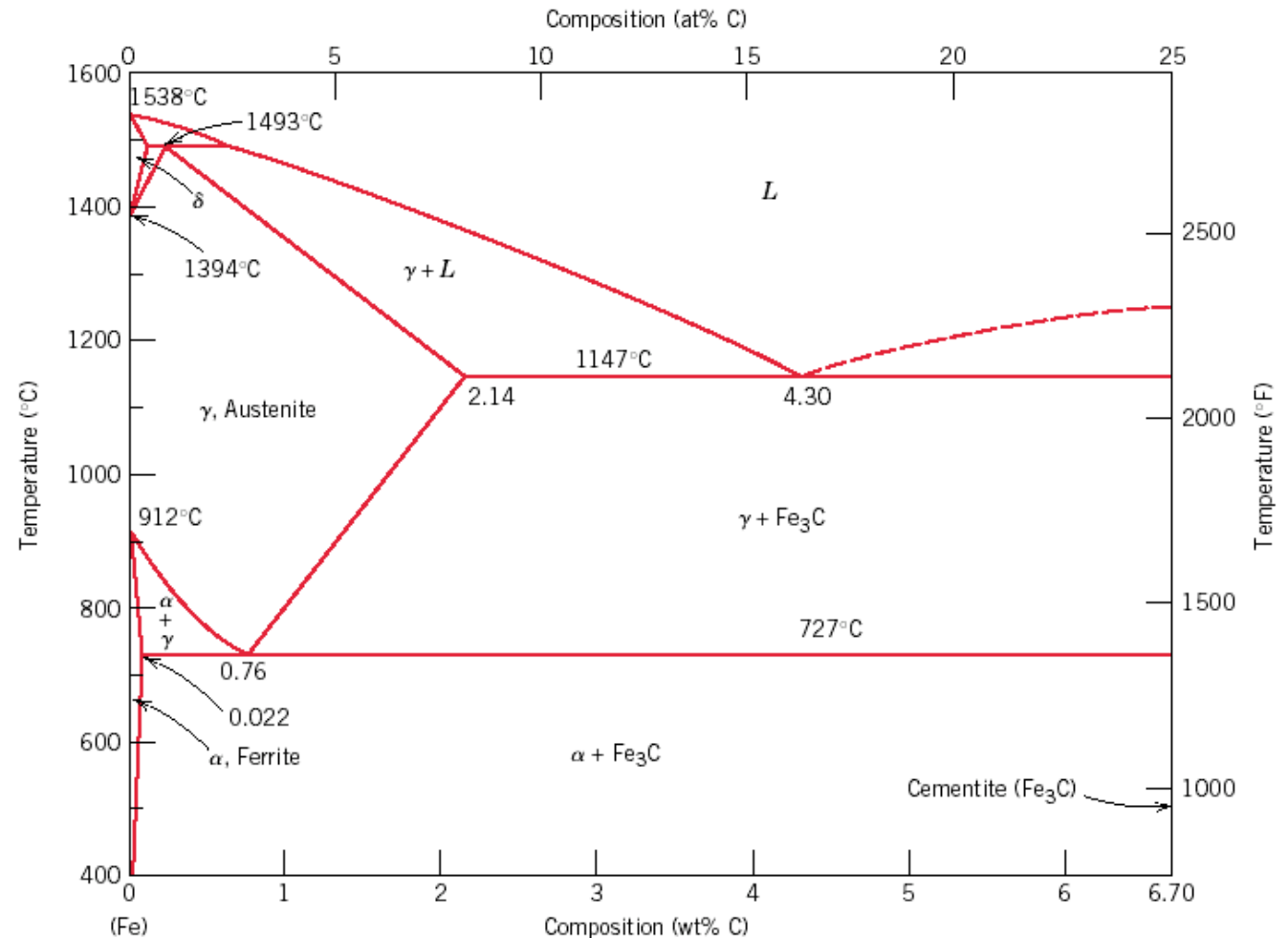


- **Peritectic** - liquid + solid 1 \rightarrow solid 2 (Fig 9.21)



The iron-iron carbide (Fe-Fe₃C) phase diagram

- Ferrite- α -BCC, low C solubility(0.022%wt), magnetic
- Austenite- γ -FCC, high C solubility(2.14%wt), nonmagnetic
- Ferrite- δ -BCC
- Cementite (Fe₃C)
- Eutectic, peritectic, eutectoid
- Iron, ferrite (C<0.008wt%)
- Stainless steel, α +Fe₃C (0.008-2.14wt %)



Phase transformation

- Nucleation/growth controlled phase transformation
- Diffusional vs diffusionless
- Rate of transformation
- Isothermal transformation diagrams



Phase Transformations

Nucleation

- nuclei (seeds) act as template to grow crystals

Driving force to nucleate increases as we increase ΔT

In ΔT range close to T_m , rate of nucleation higher with higher ΔT

- supercooling (eutectic, eutectoid)

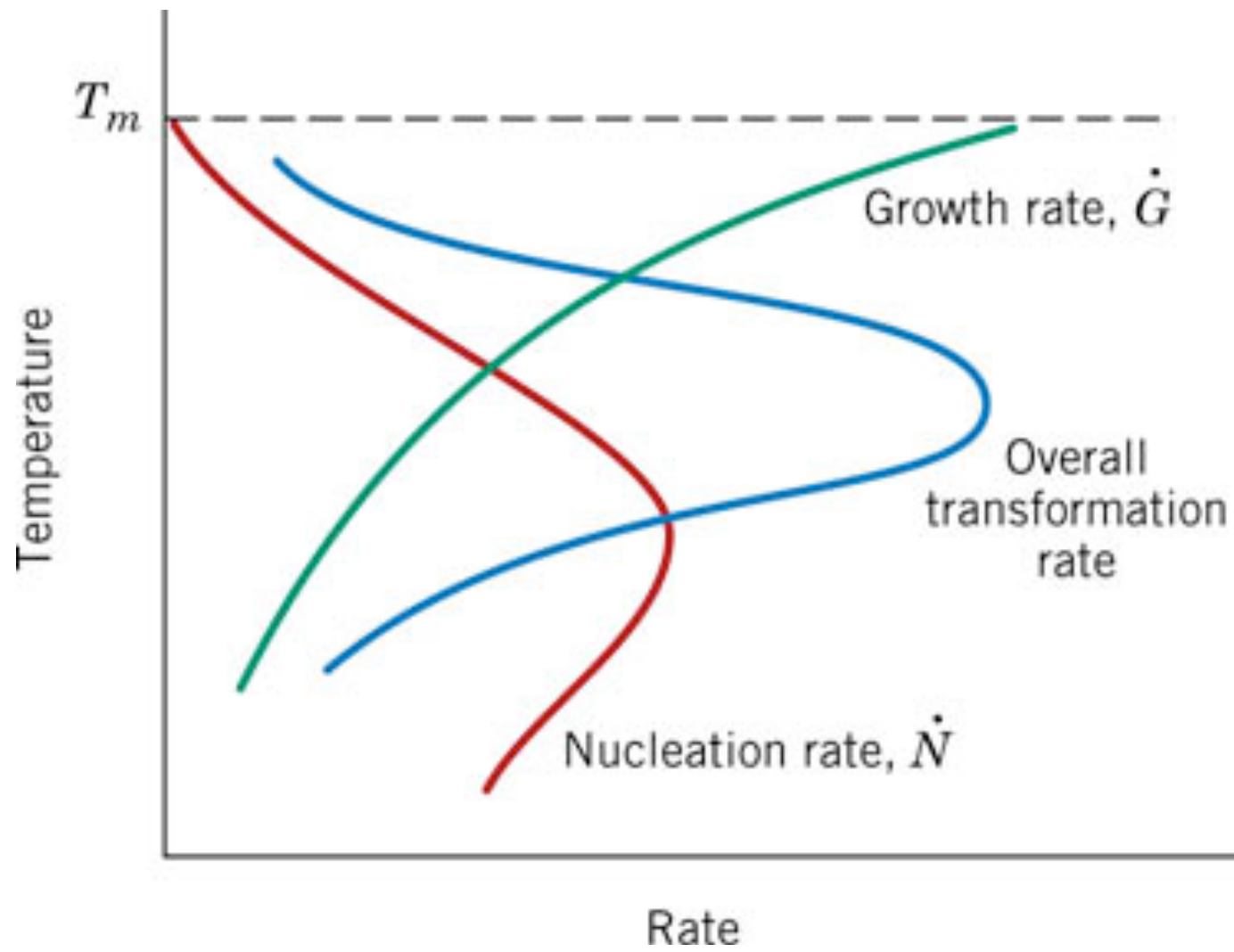
Growth

Growth rate increases with T (thermally activated)

$$dG/dt = C \exp(-Q/kT)$$

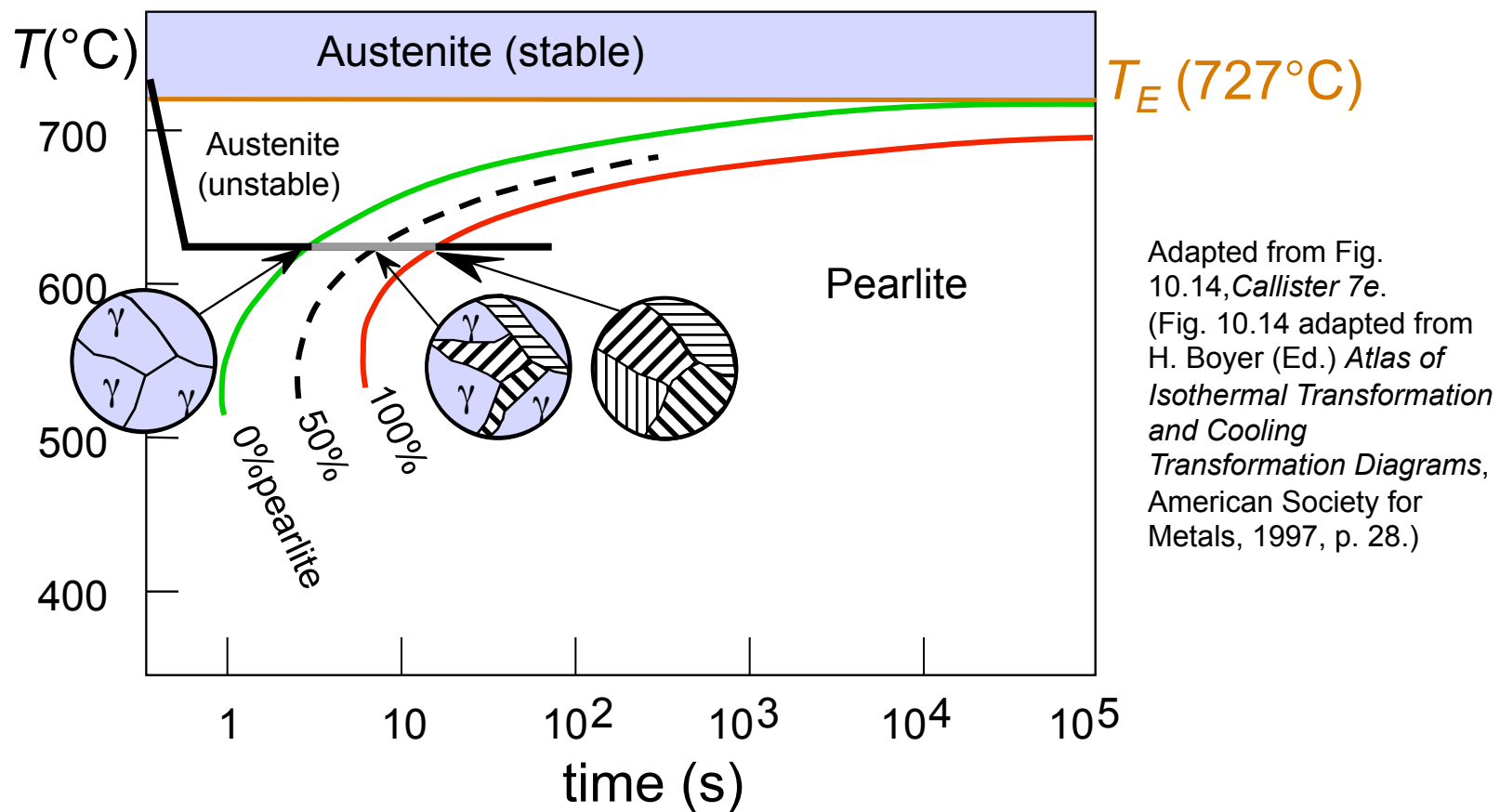
Small supercooling \rightarrow few nuclei - large crystals

Large supercooling \rightarrow rapid nucleation - many nuclei,
small crystals



Effect of Cooling History in Fe-C System

- Eutectoid composition, $C_o = 0.76 \text{ wt\% C}$
- Begin at $T > 727^\circ\text{C}$
- Rapidly cool to 625°C and hold isothermally.



Thermal processing of metals and alloys

- Quenching & tempering, annealing, precipitation
- Precipitation hardening
- Factors that influence quenching
- Hardenability



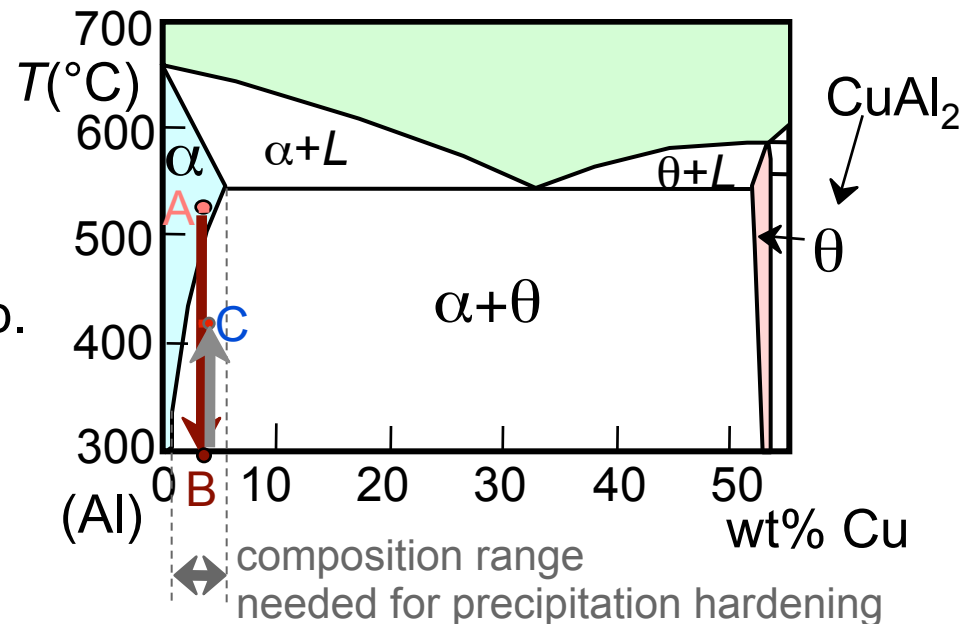
Precipitation Hardening

- Particles impede dislocations.
- Ex: Al-Cu system
- Procedure:

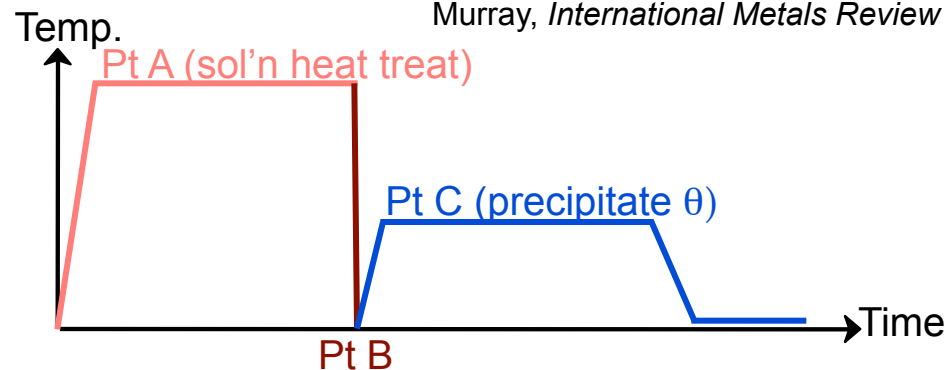
- Pt A: solution heat treat (get α solid solution)
- Pt B: quench to room temp.
- Pt C: reheat to nucleate small θ crystals within α crystals.

- Other precipitation systems:

- Cu-Be
- Cu-Sn
- Mg-Al



Adapted from Fig. 11.24, *Callister 7e*. (Fig. 11.24 adapted from J.L. Murray, *International Metals Review* **30**, p.5, 1985.)



Adapted from Fig. 11.22, *Callister 7e*.



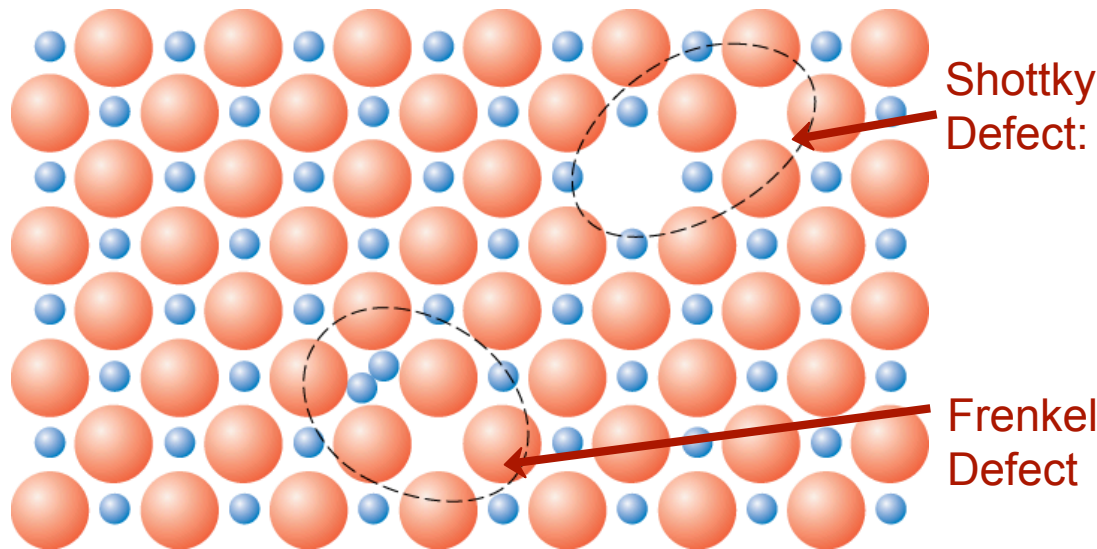
Structures and properties of ceramics

- Imperfection in ceramics
- Ceramic phase diagrams
- Mechanical properties of ceramics



Defects in Ceramic Structures

- **Frenkel Defect**
--a cation is out of place.
- **Shottky Defect**
--a paired set of cation and anion vacancies.



Adapted from Fig. 12.21, *Callister* 7e. (Fig. 12.21 is from W.G. Moffatt, G.W. Pearsall, and J. Wulff, *The Structure and Properties of Materials*, Vol. 1, *Structure*, John Wiley and Sons, Inc., p. 78.)

- Equilibrium concentration of defects $\sim e^{-Q_D / 2kT}$

Polymer properties

- Hydrocarbon molecules
 - Saturated and unsaturated
 - Bonding
 - Melting point
 - Isomerism
 - mer, monomer, polymer
- copolymer, homopolymer, blockpolymer
- molecular structures of polymers, molecular weight
- Mechanical properties of polymers
- Crystallization, melting, and glass transition phenomena
- Thermoplastic and thermosetting polymers



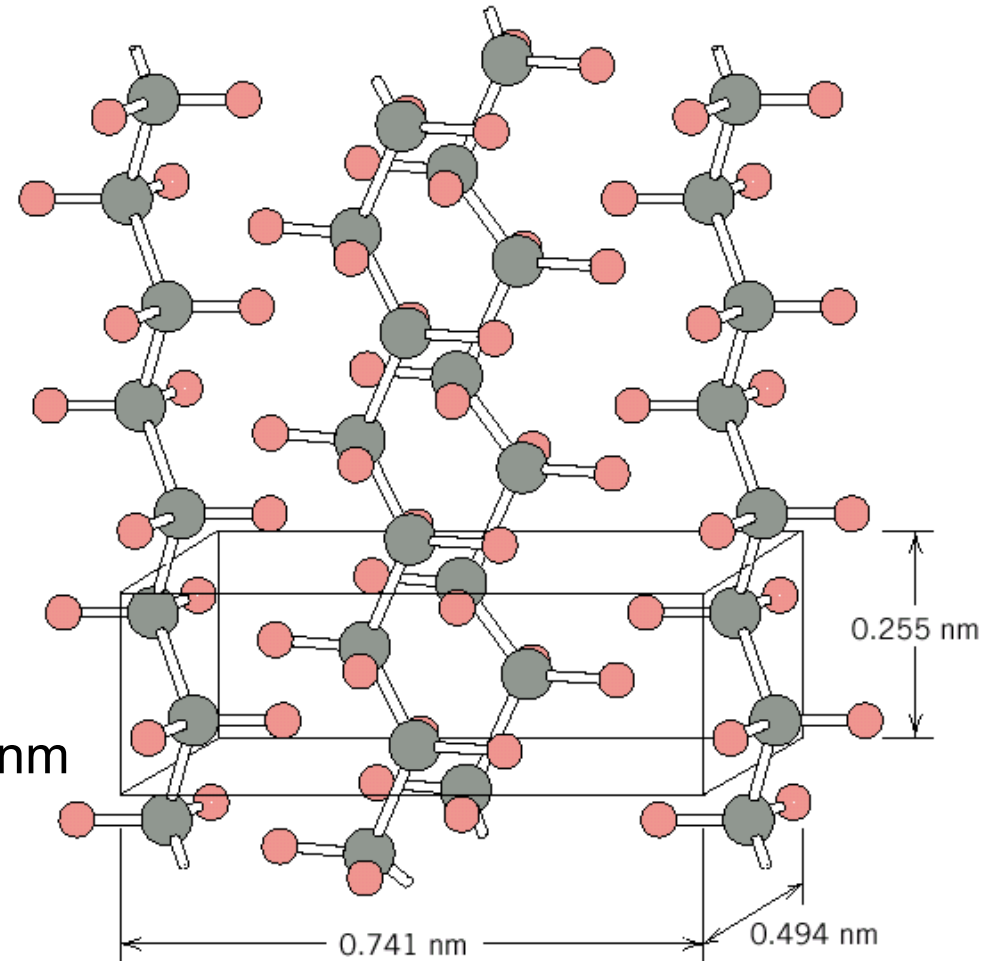
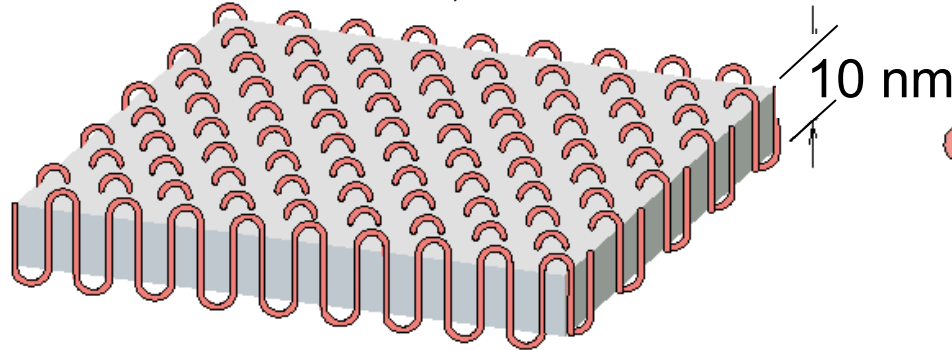
Polymer Crystallinity

Adapted from Fig.
14.10, Callister 7e.

Ex: polyethylene unit cell

- Crystals must contain the polymer chains in some way
 - Chain folded structure

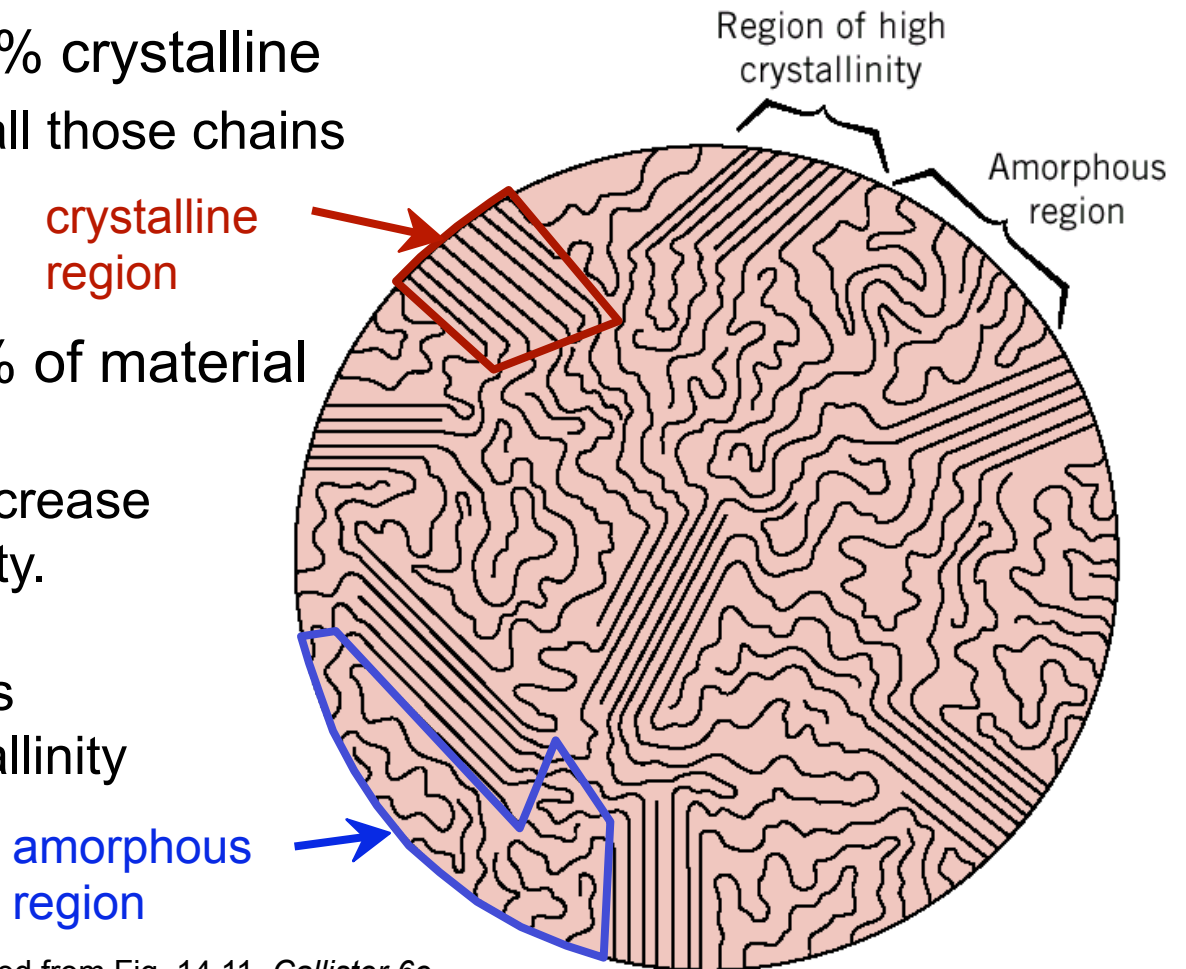
Adapted from Fig.
14.12, Callister 7e.



Polymer Crystallinity

Polymers rarely 100% crystalline

- Too difficult to get all those chains aligned
- **% Crystallinity**: % of material that is crystalline.
 - T_S and E often increase with % crystallinity.
 - Annealing causes crystalline regions to grow. % crystallinity increases.



Adapted from Fig. 14.11, *Callister 6e*.
(Fig. 14.11 is from H.W. Hayden, W.G. Moffatt,
and J. Wulff, *The Structure and Properties of
Materials*, Vol. III, *Mechanical Behavior*, John Wiley
and Sons, Inc., 1965.)



Polymers

- General drawbacks to polymers:
 - E , σ_y , K_c , $T_{\text{application}}$ are generally small.
 - Deformation is often T and time dependent.
 - Result: polymers benefit from composite reinforcement.
- **Thermoplastics** (PE, PS, PP, PC):
 - Smaller E , σ_y , $T_{\text{application}}$
 - Larger K_c
 - Easier to form and recycle
- **Elastomers** (rubber):
 - Large reversible strains!
- **Thermosets** (epoxies, polyesters):
 - Larger E , σ_y , $T_{\text{application}}$
 - Smaller K_c

Table 15.3 *Callister 7e*:

Good overview
of applications
and trade names
of polymers.

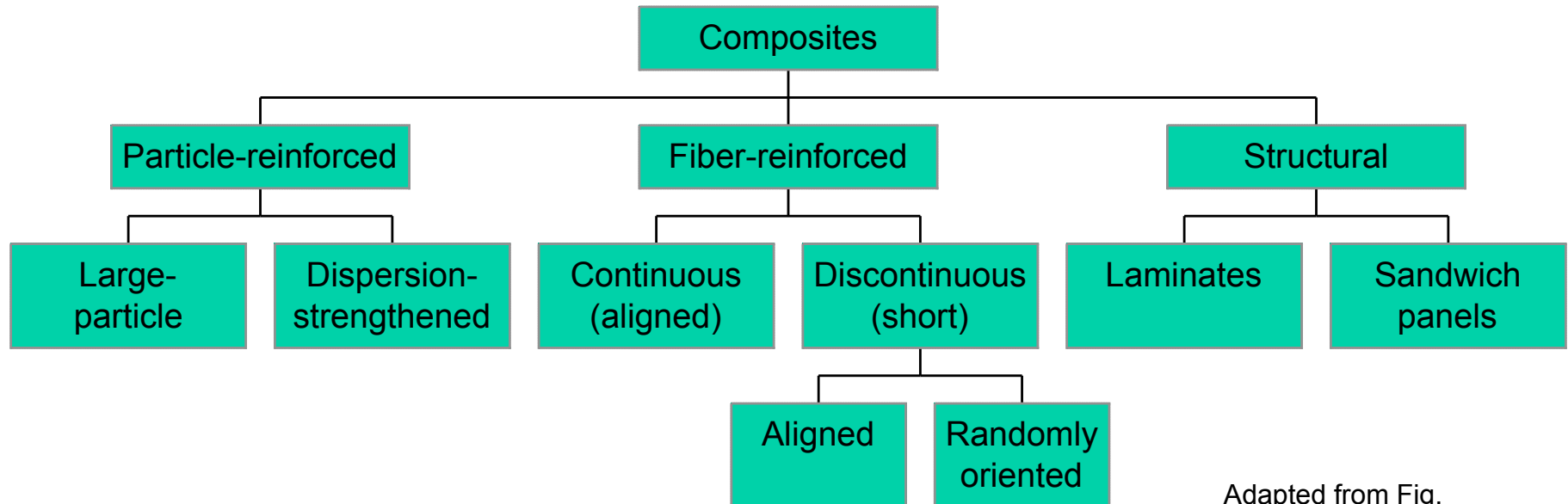


Composites

- Composites, matrix, dispersed phase
- Types of composites and characteristics of each
- Mechanical properties of composites including upper bound and lower bound of elastic modulus



Composite Survey



Adapted from Fig.
16.2, *Callister 7e*.



Composite Survey: Particle-III

Particle-reinforced

Fiber-reinforced

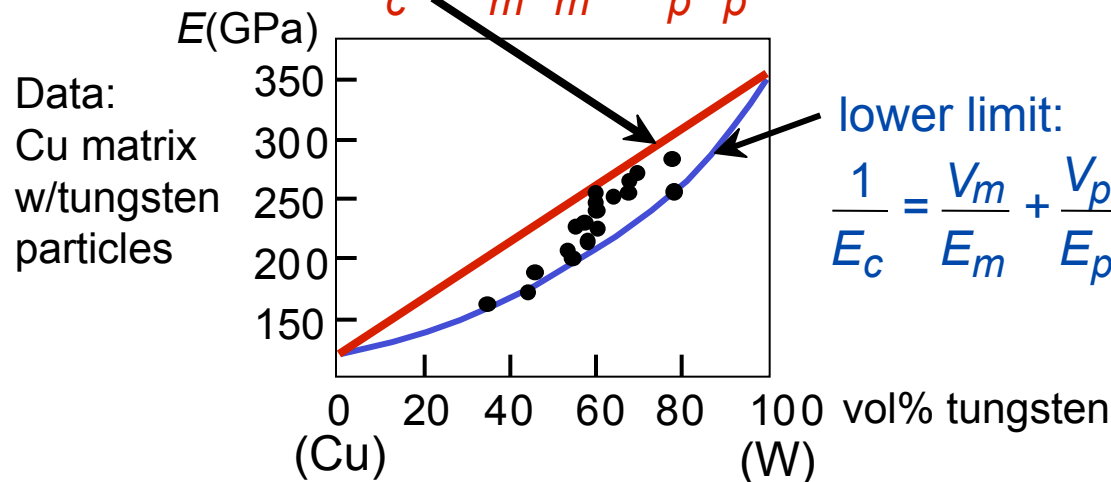
Structural

- **Elastic modulus**, E_c , of composites:

-- two approaches.

upper limit: "rule of mixtures"

$$E_c = V_m E_m + V_p E_p$$



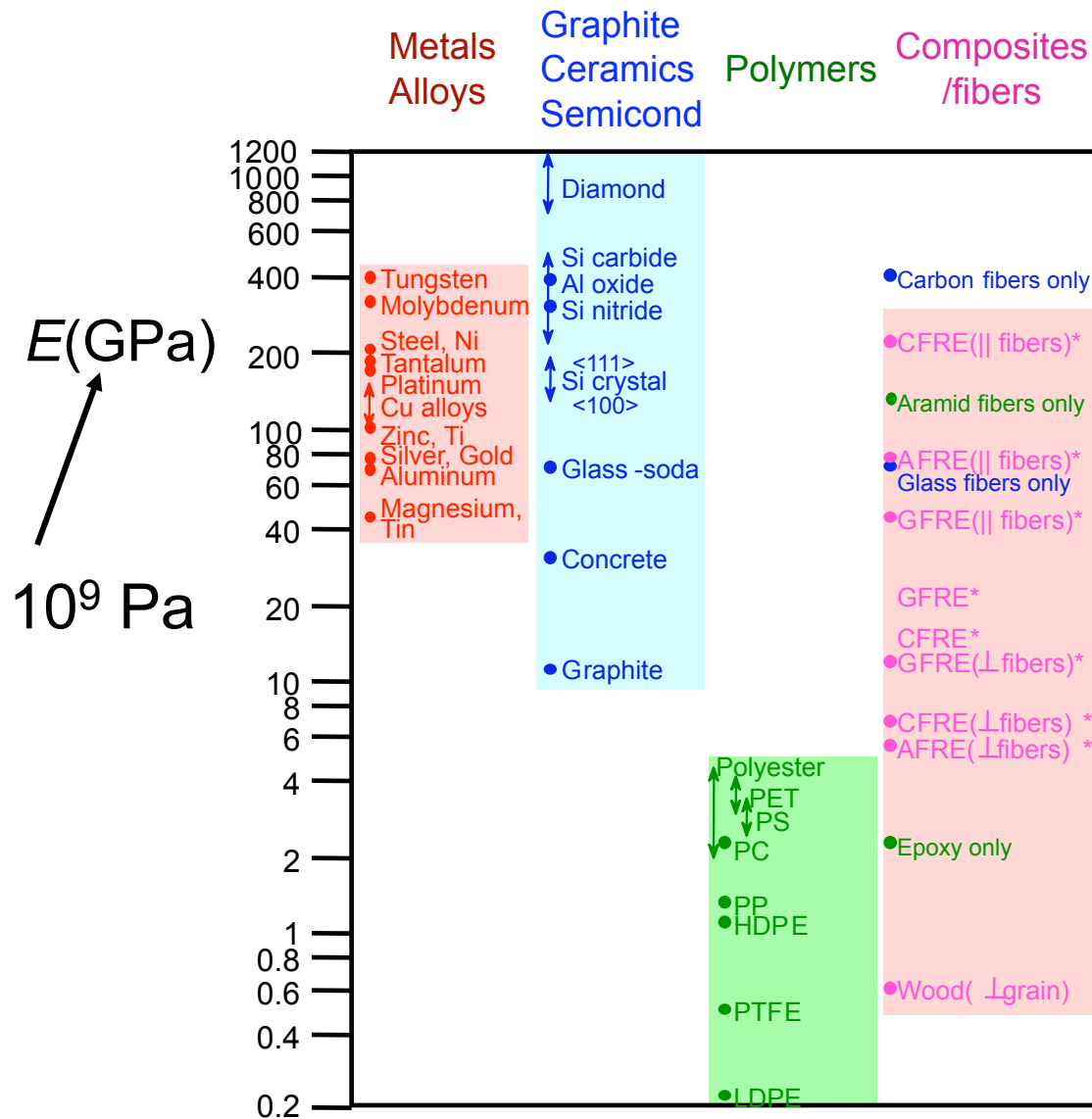
Adapted from Fig. 16.3,
Callister 7e. (Fig. 16.3 is
from R.H. Krock, *ASTM
Proc*, Vol. 63, 1963.)

- Application to other properties:

-- **Electrical conductivity**, σ_e : Replace E in equations with σ_e .
-- **Thermal conductivity**, k : Replace E in equations with k .



Young's Moduli: Comparison



Based on data in Table B2,
Callister 7e.

Composite data based on
reinforced epoxy with 60 vol%
of aligned
carbon (CFRE),
aramid (AFRE), or
glass (GFRE)
fibers.



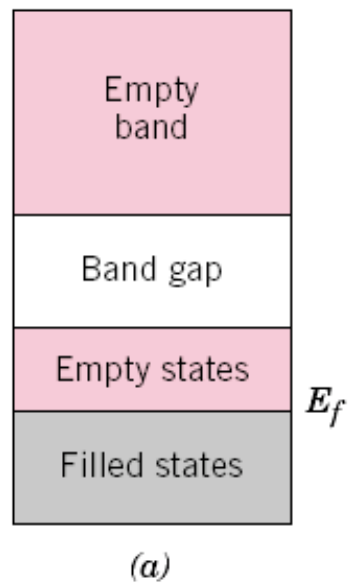
Electrical properties

- Intrinsic semiconductors
- Extrinsic semiconductors
- Energy band structure
- Electric conductivity, resistivity and mobility
- Carrier concentration
- P-N junctions and diodes

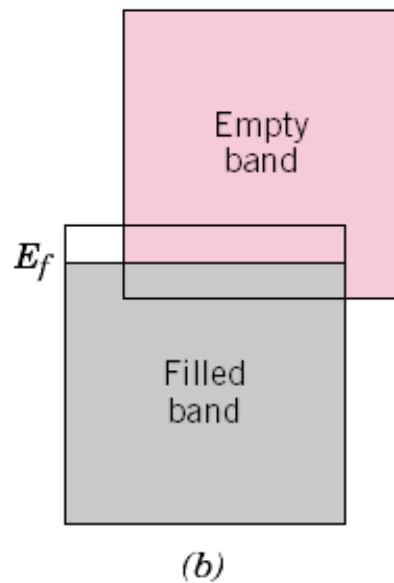


Various possible electron band structures

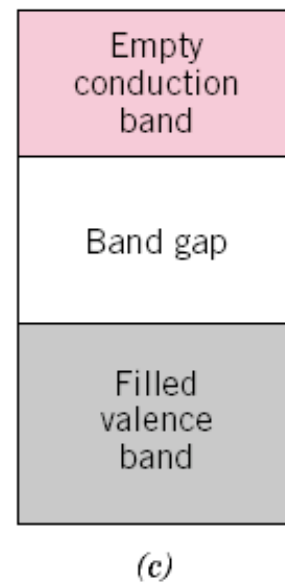
- Fermi energy E_f : the energy corresponding to the highest filled state at 0 K



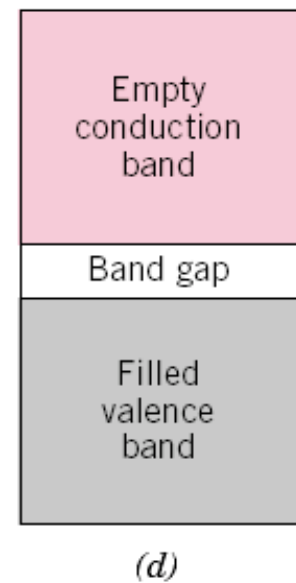
Metal (Cu)



Metal (Mg)



Insulator



Semiconductor

Ohm's Law

Further definitions

$$\boxed{J = \sigma \varepsilon} \quad \Leftarrow \text{another way to state Ohm's law}$$

$$J \equiv \text{current density} = \frac{\text{current}}{\text{surface area}} = \frac{I}{A} \quad \text{like a flux}$$

$$\varepsilon \equiv \text{electric field potential} = V/\ell \quad \text{or} \quad (\Delta V/\Delta \ell)$$

$$J = \sigma (\Delta V/\Delta \ell)$$

Diagram illustrating the components of the equation $J = \sigma (\Delta V/\Delta \ell)$:

- J (blue) is labeled "Electron flux" (blue).
- σ (red) is labeled "conductivity" (red).
- $\Delta V/\Delta \ell$ (green) is labeled "voltage gradient" (green).

Current carriers

- electrons in most solids
- ions can also carry (particularly in liquid solutions)



Electrical Properties

- Electrical **conductivity** and **resistivity** are:
 - material parameters.
 - geometry independent.
- Electrical **resistance** is:
 - a geometry and material dependent parameter.
- Conductors, semiconductors, and insulators...
 - differ in accessibility of energy states for conductance electrons.
- For metals, conductivity is increased by
 - reducing deformation
 - reducing imperfections
 - decreasing temperature.
- For pure semiconductors, conductivity is increased by
 - increasing temperature
 - doping (e.g., adding B to Si (*p*-type) or P to Si (*n*-type)).



Good Luck!